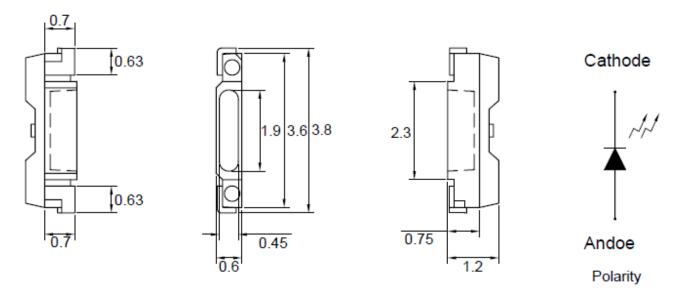


3.8 x 0.6 x 1.2 Blue Right Angle SMD, Tape and Reel

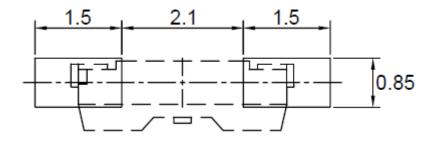
PACKAGE OUTLINES



NOTES:

- 1. All dimension is in millimeter; tolerance ±0.2mm unless otherwise noted;
- 2. Specifications are subject to change without notice.

RECOMMENDED SOLDERING PAD DIMENSIONS



NOTES: All dimensions are in millimeter; tolerance ±0.1mm unless otherwise noted

Part Number	Material	Lens Color	
rait Number	Mattiai	Emitted	Lens
L234QBC- TR	InGaN	Blue	Water Clear



3.8 x 0.6 x 1.2 Blue Right Angle SMD, Tape and Reel

ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

Parameter	Symbol	Ratings	Unit
Power Dissipation	P _D	108	mW
Peak Forward Current (Duty 1/10@10KHz)	I _{fp}	100	mA
Forward Current	I _f	30	mA
Reverse Current @ 5V	I _r	50	μΑ
Electrostatic Discharge	ESD	500	V
Operating temperature range	T _{opr}	-20~+80	°C
Storage temperature range	T _{stg}	-30~+100	°C
LED Junction Temperature	Tj	115	°C
Thermal Resistance	R _{th} ^{j-s}	60	°C/W

OPTICAL-ELECTRICAL CHARACTERISTICS

(Ta=25°C)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Luminous Intensity	I _v	I _F =20mA	125	200	1	mcd
Dominant Wavelength	λ_{D}			455		nm
Spectral Line Half-Width	Δλ			30		nm
Forward Voltage	V _f		2.8		3.6	V
Viewing angle	20 1/2			120		Deg

^{*}Note: 1. The forward voltage data did not include ±0.1V testing tolerance.

^{2.} The luminous intensity data did not include ±15% testing tolerance.



3.8 x 0.6 x 1.2 Blue Right Angle SMD, Tape and Reel

TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES

Fig.1 Forward current vs. Forward Voltage

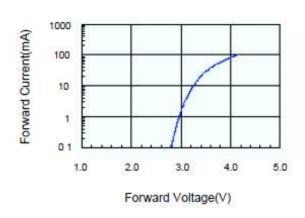


Fig.2 Relative Intensity vs. Forward Current

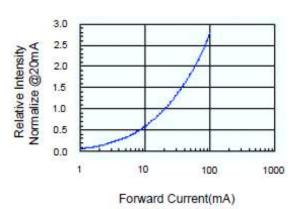
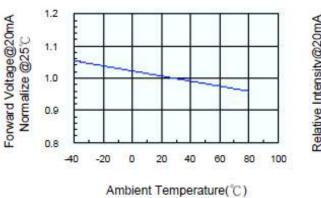


Fig.3 Forward Voltage vs. Temperature





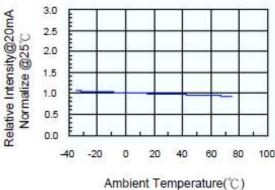


Fig.5 Relative Intensity vs. Wavelength

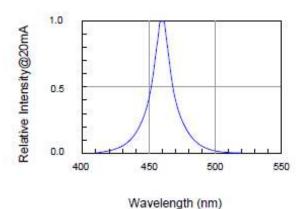
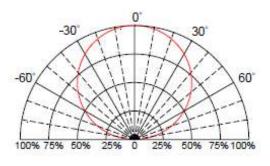


Fig.6 Directive Radiation





3.8 x 0.6 x 1.2 Blue Right Angle SMD, Tape and Reel

BIN CODE LIST

 $I_F=20mA$

Luminous	Unit: mcd	
BIN Code	Min.	Max.
R	125	200
S	200	320
Т	320	500
U	500	800

 $I_F=20mA$

Dominant Wa	Dominant Wavelength Classification Unit: nm			
Bin Code	Min.	Max.		
OI	450	453		
0H	453	456		
0G	456	459		
0F	459	462		

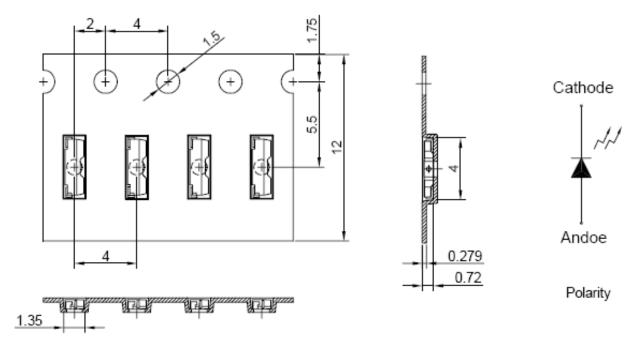
 $I_F=20mA$

Forward	Unit: V	
BIN Code	Min.	Max.
1	2.8	3.0
2	3.0	3.2
3	3.2	3.4
4	3.4	3.6



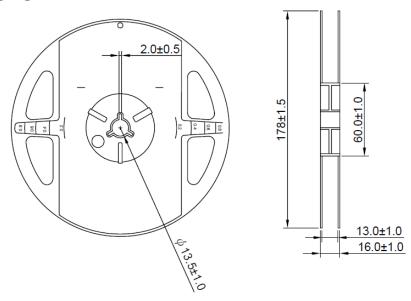
3.8 x 0.6 x 1.2 Blue Right Angle SMD, Tape and Reel

CARRIER TAPE DIMENSION



Note: The tolerances unless mentioned are ±0.1mm, Angle ±0.5

REEL DIMENSIONS



Notes:

1. 3000 pieces per reel.



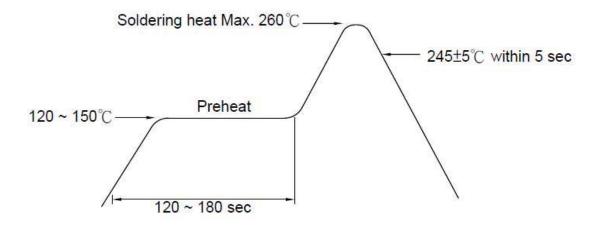
3.8 x 0.6 x 1.2 Blue Right Angle SMD, Tape and Reel

RECOMMENDED SOLDERING CONDITIONS

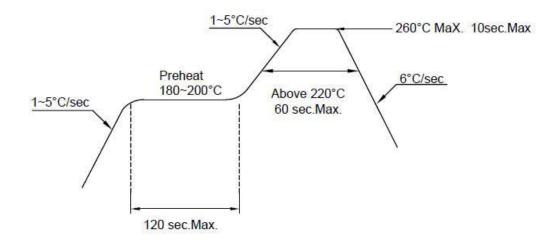
1. Hand Solder

Basis spec is ≤ 320°C for 3 sec

2. Wave Solder



3. PB-Free Reflow Solder



Notes:

- 1. Reflow soldering should not be done more than two times.
- 2. When soldering, do not put stress on the LEDs during heating.
- 3. After soldering, do not warp the circuit board.



3.8 x 0.6 x 1.2 Blue Right Angle SMD, Tape and Reel

PRECAUTIONS FOR USE

Storage Time:

- 1. The operation of temperatures and RH are: 5°C~35°C, RH60%.
- 2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with descanting agent. Considering the tape life, we suggest our customers to use our products within a year (from production date).
- 3. If opened more than one week in an atmosphere 5°C~35°C, RH60%, they should be treated at 60°C±5°C for 15hrs.

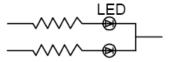
Drive Method:

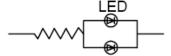
LED is a current operated device, and therefore, require some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in a series with the LED.

Consider worst case voltage variations that could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.

Circuit model A

Circuit model B





- (A) Recommended circuit.
- (B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling these LEDs. All devices and machinery must be properly grounded.



3.8 x 0.6 x 1.2 Blue Right Angle SMD, Tape and Reel

RELIABILITY TEST:

(1) Test items and results

Classification	Test Item	Test Conditions	Sample Size
	Operating Life Test	1. Ta=under room temperature as per data sheet maximum rating 2. If=20mA 3. t=1000 hrs	22
ice Test	High Temperature Storage Test	1. Ta=105°C±5°C 2. t=500 hrs	22
Endurance Test	Low Temperature Storage Test	1. Ta=40°C±5°C 2. t=1000 hrs	22
	High Temperature High Humidity Storage Test	1. IR-Reflow in-board, 2 times 2. Ta=85°C±5°C 3. RH=90%~95% 4. t=500hrs±2hrs	22
Test	Thermal Shock Test	1. IR-Reflow in-board, 2 times 2. Ta=105°C±5°C & -40°C±5°C (30min) (30min) 3. Total 100 cycles	22
Environmental Test	Reflow Soldering Test	1. Tsol=260°C±5°C 2. Dwell time = 10 max	22
	Temperature Cycling	1. 105°C ~ 25°C ~ -40°C 30 mins 15 mins 30 mins 2. 100 cycles	22

(2) Criteria for judging the damage

Item	Symbol	Test Conditions	Criteria for Judgement		
			Min.	Max.	
Forward Voltage	V_{f}	I _f =20mA		U.S.L. x 1.2	
Reverse Current	l _r	V _r =5V		U.S.L. x 2.0	
Luminous Intensity	I _v	I _f =20mA	L.S.L. x 0.5		

Note:

1. U.S.L.: Upper Standard Level. 2. L.S.L: Lower Standard Level

Version 1.1 Date: 9-2-2014 Specifications are subject to change without notice.

American Opto Plus LED Corp. 1206 E. Lexington Ave., Pomona CA 91766 Tel: 909-465-0080 Fax: 909-465-0130 www.aopled.com